## LMV821, LMV822, LMV824

## Single, Dual, Quad Low Voltage, Rail-to-Rail Operational Amplifiers

The LMV821, LMV822, and LMV824 are operational amplifiers with low input voltage offset and drift vs. temperature. In spite of low quiescent current requirements these devices have 5 MHz bandwidth and $1.4 \mathrm{~V} / \mu \mathrm{s}$ slew rate. In addition they provide rail-to-rail output swing into $600 \Omega$ loads. The input common-mode voltage range includes ground, and the maximum input offset voltage is only 3.5 mV . Substantially large capacitive loads can be driven by simply adding a pullup resistor or isolation resistor.

The LMV821 (single) is available in a space-saving SC70-5 while the dual and quad also come in ultra small SOIC and TSSOP packages.

## Features

- Low Offset Voltage: 3.5 mV
- Very low Offset Drift: $1.0 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$
- High Bandwidth: 5 MHz
- Rail-to-Rail Output Swing into a $600 \Omega$ load
- Capable of driving highly capacitive loads
- Small Packages:

LMV821 in SC-70
LMV822 in Micro8* and SOIC-8*
(*Contact Sales for Package Availability)
LMV824 in SOIC-14 and TSSOP-14

- These Devices are $\mathrm{Pb}-$ Free and are RoHS Compliant


## Typical Applications

- Notebook Computers
- PDAs
- Modem Transmitter/ Receivers



## ORDERING AND MARKING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 11 of this data sheet.


Figure 1. Gain vs. Frequency


Figure 2. CMRR vs. Input Common Mode Voltage

## LMV821，LMV822，LMV824

MARKING DIAGRAMS

（Note：Microdot may be in either location）

Micro8
8 月月明
V822
AYW：
1
1 明明
V822＝Specific Device Code
A＝Assembly Location
Y＝Year
W＝Work Week
－＝Pb－Free Package
（Note：Microdot may be in either location）

（Note：Microdot may be in either location）

SOIC－14
14日月 日 В Н 月 日
LMV824G AWLYWW


| LMV824 | $=$ Specific Device Code |
| :--- | :--- |
| A | $=$ Assembly Location |
| WL | $=$ Wafer Lot |
| Y | $=$ Year |
| WW | $=$ Work Week |
| G | $=$ Pb－Free Package |

TSSOP－14
14 月月
LMV
824
ALYW．
$0 \quad$.

LMV824 $=$ Specific Device Code
A＝Assembly Location
L＝Wafer Lot
Y＝Year
W＝Work Week
－＝Pb－Free Package
（Note：Microdot may be in either location）

PIN CONNECTIONS


## LMV821, LMV822, LMV824

MAXIMUM RATINGS

| Symbol | Rating | Value | Unit |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{S}}$ | Supply Voltage (Operating Range $\mathrm{V}_{\mathrm{S}}=2.7 \mathrm{~V}$ to 5.5 V ) | 5.5 | V |
| $V_{\text {IDR }}$ | Input Differential Voltage | $\pm$ Supply Voltage | V |
| VICR | Input Common Mode Voltage Range | -0.5 to (V+) +0.5 | V |
|  | Maximum Input Current | 10 | mA |
| tso | Output Short Circuit (Note 1) | Continuous |  |
| TJ | Maximum Junction Temperature (Operating Range $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ ) | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\theta_{\mathrm{JA}}$ | Thermal Resistance |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | SC-70 | 280 |  |
|  | Micro8 | 238 |  |
|  | SOIC-8 | 212 |  |
|  | SOIC-14 | 156 |  |
|  | TSSOP-14 | 190 |  |
| $\mathrm{T}_{\text {STG }}$ | Storage Temperature | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |
|  | Mounting Temperature (Infrared or Convection - 20 sec ) | 235 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{V}_{\text {ESD }}$ | ESD ToleranceMachine Model <br> Human Body Model | $\begin{aligned} & 200 \\ & 2000 \end{aligned}$ | V |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Continuous short-circuit operation to ground at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of $150^{\circ} \mathrm{C}$. Output currents in excess of 45 mA over long term may adversely affect reliability. Shorting output to either $\mathrm{V}+\mathrm{or} \mathrm{V}$ will adversely affect reliability.
2.7V DC ELECTRICAL CHARACTERISTICS Unless otherwise noted, all min $/ \mathrm{max}$ limits are guaranteed for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}+=2.7 \mathrm{~V}$, $\mathrm{V}-=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=\mathrm{V}+/ 2, \mathrm{~V}_{\mathrm{O}}=\mathrm{V}+/ 2$ and $\mathrm{R}_{\mathrm{L}}>1 \mathrm{M} \Omega$. Typical specifications represent the most likely parametric norm. Min/Max specifications are guaranteed by testing, characterization, or statistical analysis.

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{IO}}$ |  |  | 1 | 3.5 | mV |
|  |  |  |  |  | 4 |  |

2.5V DC ELECTRICAL CHARACTERISTICS Unless otherwise noted, all min/max limits are guaranteed for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}+=2.5 \mathrm{~V}$, $\mathrm{V}-=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=\mathrm{V}+/ 2, \mathrm{~V}_{\mathrm{O}}=\mathrm{V}+/ 2$ and $\mathrm{R}_{\mathrm{L}}>1 \mathrm{M} \Omega$. Typical specifications represent the most likely parametric norm. Min/Max specifications are guaranteed by testing, characterization, or statistical analysis.

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $\mathrm{V}_{10}$ | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | 1 | 3.5 | mV |
|  |  |  |  |  | 4 |  |
| Output Swing | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{R}_{\mathrm{L}}=600 \Omega$ to 1.25 V | 2.3 | 2.37 |  | V |
|  |  | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 2.2 |  |  |  |
|  | $\mathrm{V}_{\text {OL }}$ | $\mathrm{R}_{\mathrm{L}}=600 \Omega$ to 1.25 V |  | 0.13 | 0.20 |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | 0.3 |  |
|  | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ to 1.25 V | 2.4 | 2.46 |  |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 2.3 |  |  |  |
|  | $\mathrm{V}_{\text {OL }}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ to 1.25 V |  | 0.08 | 0.12 |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | 0.20 |  |

2.7V AC ELECTRICAL CHARACTERISTICS Unless otherwise specified, all limits are guaranteed for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}+=2.7 \mathrm{~V}, \mathrm{~V}-=$ $0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=1.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=\mathrm{V}+/ 2$ and $\mathrm{RL}>1 \mathrm{M} \Omega$. Typical specifications represent the most likely parametric norm. Min/Max specifications are guaranteed by testing, characterization, or statistical analysis.

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Slew Rate | SR | (Note 2) |  | 1.5 |  | $\mathrm{~V} / \mathrm{uS}$ |
| Gain Bandwidth Product | GBWP |  |  | 5 |  | MHz |
| Phase Margin | $\theta_{\mathrm{m}}$ |  | 55 |  | $\circ$ |  |
| Gain Margin | $\mathrm{G}_{\mathrm{m}}$ |  |  | 12.9 |  | dB |
| Input-Referred Voltage Noise | $\mathrm{e}_{\mathrm{n}}$ | $\mathrm{f}=1 \mathrm{kHz}, \mathrm{V}_{\mathrm{CM}}=1 \mathrm{~V}$ |  | 12 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input-Referred Current Noise | $\mathrm{i}_{\mathrm{n}}$ | $\mathrm{f}=1 \mathrm{kHz}$ |  | 0.2 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Total Harmonic Distortion | THD | $\mathrm{f}=1 \mathrm{kHz}, \mathrm{AV}=-2, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{O}}=1.8 \mathrm{~V}_{\mathrm{PP}}$ |  | 0.023 |  | $\%$ |
| Amplifier-to-Amplifier Isolation |  | $($ Note 3) |  | 135 |  | dB |

2. Connected as voltage follower with input step from 0.5 V to 1.5 V . Number specified is the average of the positive and negative slew rates.
3. Input referred, $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega$ connected to $\mathrm{V}+/ 2$. Each amp excited in turn with 1 kHz to produce $\mathrm{V}_{\mathrm{O}}=3 \mathrm{~V}_{\mathrm{Pp}}$. For Supply Voltages $<3 \mathrm{~V}$, $\mathrm{V}_{\mathrm{O}}=\mathrm{V}+$.

5V DC ELECTRICAL CHARACTERISTICS Unless otherwise noted, all min/max limits are guaranteed for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-$ $=0 \mathrm{~V}, \mathrm{VCM}=\mathrm{V}+/ 2, \mathrm{~V}_{\mathrm{O}}=\mathrm{V}+/ 2$ and $\mathrm{R}_{\mathrm{L}}>1 \mathrm{M} \Omega$. Typical specifications represent the most likely parametric norm. Min/Max specifications are guaranteed by testing, characterization, or statistical analysis.

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $\mathrm{V}_{\text {IO }}$ |  |  | 1 | 3.5 | mV |
|  |  |  |  |  | 4 |  |

## LMV821, LMV822, LMV824

5V AC ELECTRICAL CHARACTERISTICS Unless otherwise specified, all limits are guaranteed for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}$, $\mathrm{V}_{\mathrm{CM}}=2.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=\mathrm{V}+/ 2$ and $\mathrm{R}_{\mathrm{L}}>1 \mathrm{M} \Omega$. Typical specifications represent the most likely parametric norm. Min/Max specifications are guaranteed by testing, characterization, or statistical analysis.

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Slew Rate | SR | (Note 4) |  | 2 |  | $\mathrm{~V} / \mathrm{uS}$ |
| Gain Bandwidth Product | GBWP |  |  | 5.6 |  | MHz |
| Phase Margin | $\theta_{\mathrm{m}}$ |  | 63 |  | $\circ$ |  |
| Gain Margin | $\mathrm{G}_{\mathrm{m}}$ |  |  | 11.7 |  | dB |
| Input-Referred Voltage Noise | $\mathrm{e}_{\mathrm{n}}$ | $\mathrm{f}=1 \mathrm{kHz}, \mathrm{V}_{\mathrm{CM}}=1 \mathrm{~V}$ | $\mathrm{f}=1 \mathrm{kHz}$ | 11 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input-Referred Current Noise | $\mathrm{i}_{\mathrm{n}}$ | THD | $\mathrm{f}=1 \mathrm{kHz}, \mathrm{A}_{\mathrm{V}}=-2, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{O}}=4.11 \mathrm{VPP}$ |  | 0.012 |  |
| Total Harmonic Distortion | (Note 5) |  | 135 |  | dB |  |
| Amplifier-to-Amplifier Isolation |  |  |  |  |  |  |

4. Connected as voltage follower with input step from 0.5 V to 3.5 V . Number specified is the average of the positive and negative slew rates.
5. Input referred, $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega$ connected to $\mathrm{V}+/ 2$. Each amp excited in turn with 1 kHz to produce $\mathrm{V}_{\mathrm{O}}=3 \mathrm{~V}_{\mathrm{Pp}}$. (For Supply Voltages $<3 \mathrm{~V}$, $\mathrm{V}_{\mathrm{O}}=\mathrm{V}+$ ).


Figure 3. Crosstalk Rejection vs. Frequency


Figure 5. -PSRR vs. Frequency


Figure 7. Gain vs. Frequency


Figure 4. +PSRR vs. Frequency


Figure 6. Gain vs. Frequency


Figure 8. Non-Inverting Stability vs. Capacitive Load


Figure 9. Gain vs. Frequency


Figure 11. Non-Inverting Small Signal Step Response


Figure 10. Non-Inverting Large Signal Step Response


Figure 12. Inverting Large Signal Step Response


Figure 13. Inverting Small Signal Step
Response

## LMV821, LMV822, LMV824

## APPLICATIONS INFORMATION



Figure 14. Voltage Reference


Figure 16. Comparator with Hysteresis


Figure 15. Wien Bridge Oscillator


Given: $f_{0}=$ center frequency

$$
A\left(f_{0}\right)=\text { gain at center frequency }
$$

Choose value $f_{0}, C_{Q}$
Then: $R 3=\frac{\pi f_{0} C}{C}$

$$
\begin{aligned}
R 1 & =\frac{R 3}{2 A\left(f_{\mathrm{O}}\right)} \\
R 2 & =\frac{R 1 R 3}{4 Q^{2} R 1-R 3}
\end{aligned}
$$

For less than 10\% error from operational amplifier, $\left(\left(Q_{O} f_{\mathrm{O}}\right) / \mathrm{BW}\right)<0.1$ where $\mathrm{f}_{\mathrm{o}}$ and BW are expressed in Hz . If source impedance varies, filter may be preceded with voltage follower buffer to stabilize filter parameters.

Figure 17. Multiple Feedback Bandpass Filter

## LMV821, LMV822, LMV824

ORDERING INFORMATION

| Order Number | Number <br> of <br> Channels | Specific Device Marking | Package Type | Shipping $^{\dagger}$ |
| :--- | :---: | :---: | :---: | :---: |
| LMV821SQ3T2G | Single | AAE | SC-70 <br> (Pb-Free) | $3000 /$ Tape \& Reel |
| LMV822DMR2G* | Dual | V822 | Micro8 <br> (Pb-Free) | $4000 /$ Tape \& Reel |
| LMV822DR2G* | Dual | V822 | SOIC-8 <br> (Pb-Free) | $2500 /$ Tape \& Reel |
| LMV824DR2G | Quad | LMV824 | SOIC-14 <br> (Pb-Free) | $2500 /$ Tape \& Reel |
| LMV824DTBR2G | Quad | LMV <br> 824 | TSSOP-14 <br> (Pb-Free) | $2500 /$ Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*Contact sales for package availability.

## LMV821, LMV822, LMV824

## PACKAGE DIMENSIONS

## SC-88A (SC-70-5/SOT-353)

CASE 419A-02
ISSUE K


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH
3. 419A-01 OBSOLETE. NEW STANDARD 419A-02.
DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

|  | INCHES |  | MILLIMETERS |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | MAX | MIN | MAX |  |
| A | 0.071 | 0.087 | 1.80 | 2.20 |  |
| B | 0.045 | 0.053 | 1.15 | 1.35 |  |
| C | 0.031 | 0.043 | 0.80 | 1.10 |  |
| D | 0.004 | 0.012 | 0.10 | 0.30 |  |
| G | 0.026 BSC |  | 0.65 BSC |  |  |
| H | --- | 0.004 | --- | 0.10 |  |
| J | 0.004 | 0.010 | 0.10 | 0.25 |  |
| K | 0.004 | 0.012 | 0.10 |  |  |
| N | 0.008 |  | REF | 0.20 |  |
| S | 0.079 | 0.087 | 2.00 |  |  |

## LMV821, LMV822, LMV824

## PACKAGE DIMENSIONS

## Micro8 $^{\text {TM }}$ <br> CASE 846A-02 <br> ISSUE H



| $\phi$ | $0.08(0.003)$ | $(1)$ | T | B (5) |
| :--- | :--- | :--- | :--- | :--- |



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE 5. 846A-01 OBSOLETE, NEW STANDARD 846A-02.

|  | MILIMETERS |  |  | INCHES |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |  |
| A | ---- |  | 1.10 | -- | -- | 0.043 |  |
| A1 | 0.05 | 0.08 | 0.15 | 0.002 | 0.003 | 0.006 |  |
| b | 0.25 | 0.33 | 0.40 | 0.010 | 0.013 | 0.016 |  |
| c | 0.13 | 0.18 | 0.23 | 0.005 | 0.007 | 0.009 |  |
| D | 2.90 | 3.00 | 3.10 | 0.114 | 0.118 | 0.122 |  |
| E | 2.90 | 3.00 | 3.10 | 0.114 | 0.118 | 0.122 |  |
| e | 0.65 BSC |  |  |  | 0.026 BSC |  |  |
| L | 0.40 | 0.55 | 0.70 | 0.016 | 0.021 | 0.028 |  |
| HE | 4.75 | 4.90 | 5.05 | 0.187 | 0.193 | 0.199 |  |

SOLDERING FOOTPRINT*

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## LMV821, LMV822, LMV824

## PACKAGE DIMENSIONS

SOIC-8 NB
CASE 751-07
ISSUE AK


| $\phi$ | $0.25(0.010)(1)$ | $Z$ | $Y(5)$ | $X(S)$ |
| :--- | :--- | :--- | :--- | :--- | :--- |

NOTES

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
. CONTROLLING DIMENSION: MILLIMETER.
2. DIMENSION A AND B DO NOT INCLUDE DIMENSION A AND B
MOLD PROTRUSION.
3. MAXIMUM MOLD PROTRUSION 0.15 (0.006) MAXIMUM
PER SIDE.
PER SIDE.
4. DIMENSION D DOES NOT INCLUDE DAMBAR DIMENSION D DOES NOT INCLUDE DA
PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE $0.127(0.005)$ TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
5. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

|  | MILLIMETERS |  | INCHES |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | MAX | MIN | MAX |  |
| A | 4.80 | 5.00 | 0.189 | 0.197 |  |
| B | 3.80 | 4.00 | 0.150 | 0.157 |  |
| $\mathbf{C}$ | 1.35 | 1.75 | 0.053 | 0.069 |  |
| $\mathbf{D}$ | 0.33 | 0.51 | 0.013 |  |  |
| $\mathbf{G}$ | 1.27 |  | BSC | 0.020 |  |
| $\mathbf{H}$ | 0.10 | 0.25 | 0.004 | 0.010 |  |
| $\mathbf{J}$ | 0.19 | 0.25 | 0.007 | 0.010 |  |
| $\mathbf{K}$ | 0.40 | 1.27 | 0.016 | 0.050 |  |
| $\mathbf{M}$ | 0 | $\circ$ | 8 | $\circ$ |  |
| $\mathbf{N}$ | 0.25 | 0.50 | 0.010 | 0.020 |  |
| $\mathbf{S}$ | 5.80 | 6.20 | 0.228 | 0.244 |  |


*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## LMV821, LMV822, LMV824

## PACKAGE DIMENSIONS

SOIC-14
CASE 751A-03
ISSUE K



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
5. MAXIMUM MOLD PROTRUSION 0.15 PER 5. MAXI.

DETAIL A

| DIM | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 1.35 | 1.75 | 0.054 | 0.068 |
| A1 | 0.10 | 0.25 | 0.004 | 0.010 |
| A3 | 0.19 | 0.25 | 0.008 | 0.010 |
| b | 0.35 | 0.49 | 0.014 | 0.019 |
| D | 8.55 | 8.75 | 0.337 | 0.344 |
| E | 3.80 | 4.00 | 0.150 | 0.157 |
| e | 1.27 BSC |  | 0.050 BSC |  |
| H | 5.80 | 6.20 | 0.228 | 0.244 |
| h | 0.25 | 0.50 | 0.010 | 0.019 |
| L | 0.40 | 1.25 | 0.016 | 0.049 |
| M | $0^{\circ}$ | $7^{\circ}$ | $0^{\circ}$ | $7^{\circ}$ |



SOLDERING FOOTPRINT*


DIMENSIONS: MILLIMETERS
*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## LMV821, LMV822, LMV824

## PACKAGE DIMENSIONS



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